

MODEL NO.
BL9664AERNHn\$
VER.05



FOR MESSRS:		
ON DATE OF:		
APPROVED BY:		

BOLYMIN, INC.

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History of Version

Version	Contents	Date	Note
01	NEW VERSION	2009/09/01	SPEC.
02	Add contrast setting Modify seal color (white→black)	2011/11/9	
03	UPDATE Quality Assurance · Reliability ADD Precautions for Handling · Precautions for Electrical · Precautions for Storage	2012/10/02	
04	Modify Cover page	2012/10/17	N
05	Modify Quality Assurance	2013/02/21	
06	Modify Drawing	2013/07/18	



CONTENTS

- 1. Numbering System
- 2. General Specification
- 3. Absolute Maximum Rating
- 4. Electrical Characteristics
- 5. Optical Characteristics
- 6. Interface Pin Function6.1 MCU Interface Selection
- 7. Block Diagram
- 8. Drawing
- 9. SSD1325 controller data
 - 9.1 Timing Characteristics
 - 9.2 Display Control Instruction
 - 9.3 Power ON and OFF sequence& Application Circuit
- 10. Quality Assurance
 - 10.1 Inspection conditions
 - 10.2 Inspection Parameters
 - 10.3 WARRANTY POLICY
 - 10.4 MTBF
- 11. Reliability
- 12. Precautions for Handling
- 13. Precautions for Electrical
 - 13.1 Design using the settings in the specification
 - 13.2 Maximum Ratings
 - 13.3 Power on/off procedure
 - 13.4 Power savings
 - 13.5 Residual Image (Image Sticking)
- 14. Precautions for Storage



1. Numbering System

<u>B</u>	L L	<u>9664</u>	<u>A</u>	<u>E</u>	<u>R</u>	<u>N</u>	=	<u>H</u>	<u>n\$</u>	
0	1	2	3	4	5	6	7	8	9	

0	Brand	Bolymin	
1	Module Type	C= character type G= graphic type P= TAB/TCP type R=color STN	O= COG type F= COF type L=PLED/OLED
2	Format	2002=20 characters, 2 lines 12232= 122 x 32 dots	
3	Version No.	A type	
4	LCD Color	W=OLED/White G=STN/gray Y=STN/yellow-green C=color STN	B=blue F=FSTN T=TN
5	LCD Type	R=positive/reflective P=positive/transflective	M=positive/transmissive N=negative/transmissive
6	Backlight type/color	L=LED array/ yellow-green H=LED edge/white R=LED array/red G=LED edge/yellow-green F=RGB Q=LED edge/red A=LED edge/amber N=No backlight	D=LED edge/blue E=EL/white B=EL/blue C=CCFL/white Y=LED Bottom/yellow O=LED array/orange K=LED edge/green A=LED edge/amber
7	CGRAM Font (applied only on character type)	J=English/Japanese Font E=English/European Font G=Chinese(simple) F=Chinese(traditional)	C=English/Cyrillic Font H=English/Hebrew Font A=English/Arabic Font
8	View Angle/ Operating Temperature	B=Bottom/Normal Temperature H=Bottom/Wide Temperature U=Bottom/Ultra wide Temperature	T=Top/Normal Temperature W=Top/Wide Temperature C=9H/Normal Temperature E=Top/ultra wide temperature
9	Special Code	n=positive voltage for LCD \$:RoHS	



2. General Specification

(1) Mechanical Dimension

Item	Standard Value	Unit
Number of dots	96x64	dots
Module dimension (L*W*H)	29*50.5*1.61	mm
Active area	23.49*15.65	mm
Dot size	0.215(W)×0.215(H)	mm
Dot pitch	0.245(W)×0.245 (H)	mm
Color	Yellow	

(2) Controller IC: SSD1325 Controller

(3) Temperature Range

Operating		-40 ~ +70°C		
Storage	DO	-40 ~ +85°C		

3. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	ТОР	-40	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	TST	-40	_	+85	$^{\circ}\!\mathbb{C}$
Input Voltage (VDD)	VDD	-0.3	_	3.5	V
Supply Voltage (Vcc)	Vcc	8	_	16	V
Humidity	_	_	_	85	%
Operating lift time	_	_	33000(1)	_	Hrs
Operating lift time	_	_	40000(2)	_	Hrs
Operating lift time		_	50000(3)	_	Hrs

Note: (A) Under Vcc = 12V, $Ta = 25^{\circ}C$, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(C) Note (1) \cdot Note (2) \cdot Note (3) contrast setting are under VDD = 2.7V

(1) Setting of 120 cd/m :

Contrast setting :0x73H Frame rate : 105Hz Duty setting : 1/64

(2) Setting of 100 cd/m :

Contrast setting :0x56H Frame rate : 105Hz Duty setting : 1/64

(3) Setting of 80 cd/m :

Contrast setting :0x40H Frame rate : 105Hz Duty setting : 1/64



4. Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	2.4	2.7	3.5	V
Supply Voltage For Panel	Vcc-Vss	_	11.5	12	12.5	V
Input High Vol	V _{IH}	_	$0.8V_{\mathrm{DD}}$	_	V_{DD}	V
Input Low Vol	$V_{\rm IL}$	_	0	_	$0.2V_{\mathrm{DD}}$	V
Output High Vol	V_{OH}	_	$0.9V_{DD}$	_	V_{DD}	V
Output Low Vol.	V_{OL}	_	0	_	$0.1V_{DD}$	V
Supply Current	I_{DD}	_	_	40	_	mA
Supply Current	I_{CC}	_	_	700	_	uA

5. Optical Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
View Angle	θ	160		_	deg
Dark Room contrast	CR	2000:1	_		_
Response Time	Т	-	10	-	us



6. Interface Pin Function

6. 1 Pin Description

Pin No.	Symbol	Level	Description
1	Vss	0V	Ground
2	Vdd	3.3V	Supply voltage for logic
3	CS	H/L	Chip select pin
4	/RES	H/L	Hardware Reset pin
5	D/C	H/L	H: Data; L: Command.
6	WR	H/L	write signal pin
7	RD	H/L	Read signal pin
8	DB0	H/L	Data bus line
9	DB1	H/L	Data bus line
10	DB2	H/L	Data bus line
11	DB3	H/L	Data bus line
12	DB4	H/L	Data bus line
13	DB5	H/L	Data bus line
14	DB6	H/L	Data bus line
15	DB7	H/L	Data bus line
	DISF	H/L	DISF: VCC Voltage ON/OFF
16	VCC	Н	VCC: Supply Voltage For OLED

Default: Parallel 8-Bit 8080 Interface

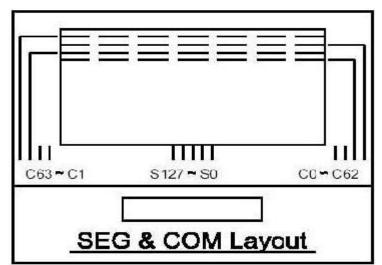
68j : Parallel 8-Bit 6800 Interface Special Code

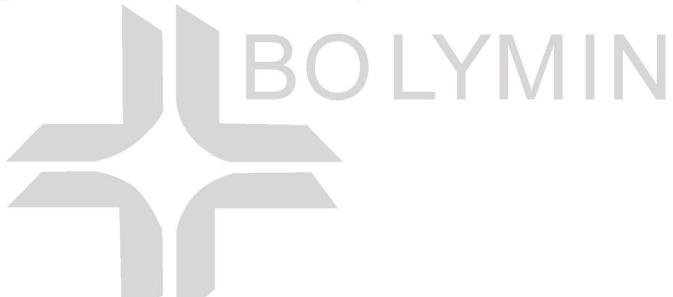
20i : SPI Interface Special Code

Pin Name Bus	Data/0	Data/Command Interface								ol Signal	I		
Interface	D 7	D 6	D5	D 4	D 3	E	R /W#	CS#	D /C#	RES#			
8-bit 8080				D	[7:0]				RD#	WR#	CS#	D/C#	RES#
8-bit 6800		D[7:0]							Е	R/W#	CS#	D/C#	RES#
SPI	Tie LO	OW				NC	SDIN	SCLK	Tie LO	W	CS#	D/C#	RES#



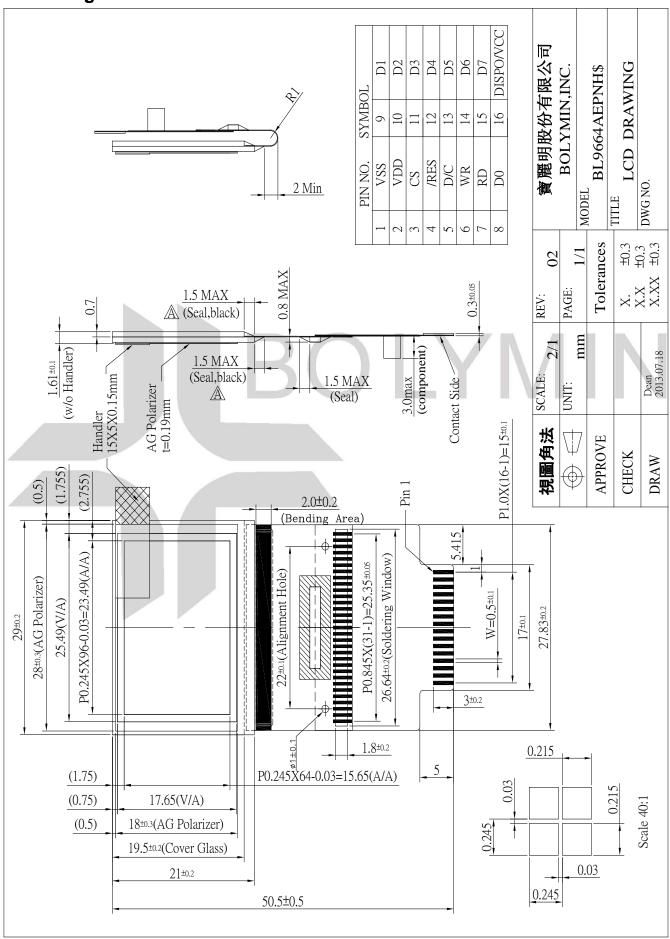
7. Block Diagram







8. Drawing



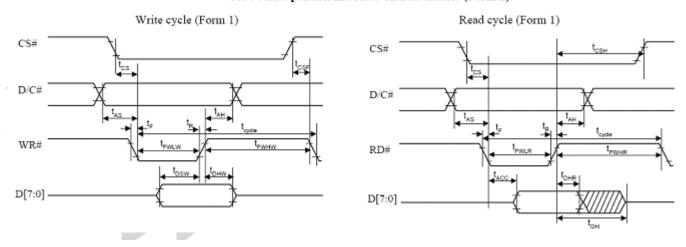


9. SSD1325controller data

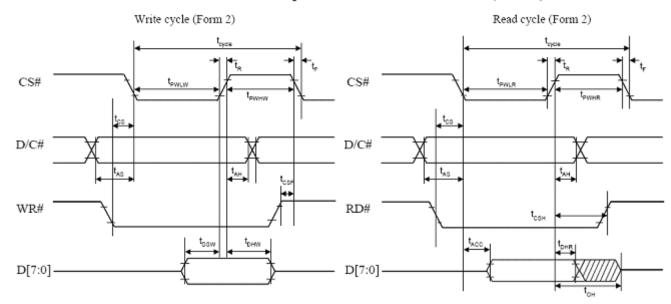
9.1 Timing Characteristics 8080 MPU Interface

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t _{DSW}	Write Data Setup Time	40	-	-	ns
t _{DHW}	Write Data Hold Time	15	-	-	ns
t _{DHR}	Read Data Hold Time	20	-	-	ns
t _{OH}	Output Disable Time	-	-	70	ns
t _{ACC}	Access Time	-	-	140	ns
t _{PWLR}	Read Low Time	120	-	-	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t _{PWHR}	Read High Time	60	-	-	ns
t _{PWHW}	Write High Time	60	-	-	ns
t _R	Rise Time	-	-	15	ns
$t_{\rm F}$	Fall Time	-	-	15	ns
t _{CS}	Chip select setup time	0	-	-	ns
t _{CSH}	Chip select hold time to read signal	0	-	-	ns
t _{CSF}	Chip select hold time	20	-	-	ns

8080-series parallel interface characteristics (Form 1)



8080-series parallel interface characteristics (Form 2)

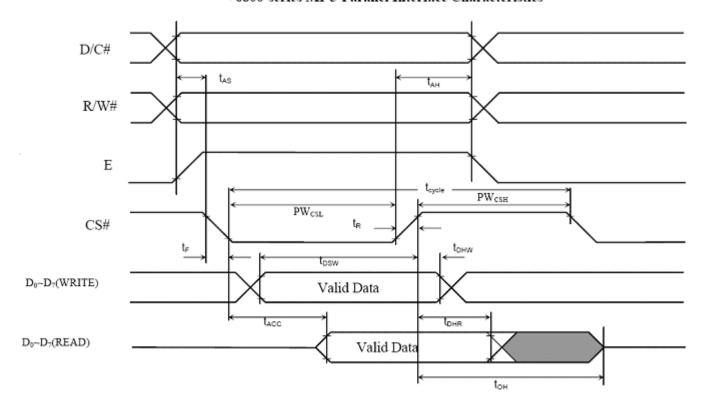




6800 MPU Interface

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	300	-	-	ns
t _{AS}	Address Setup Time	0	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t _{DSW}	Write Data Setup Time	40	-	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	-	ns
t _{DHR}	Read Data Hold Time	20	-	-	ns
t _{OH}	Output Disable Time	-	-	70	ns
t _{ACC}	Access Time	-	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (read)	120	-	-	ns
	Chip Select Low Pulse Width (write)	60			
PW_{CSH}	Chip Select High Pulse Width (read)	60	-	-	ns
	Chip Select High Pulse Width (write)	60			
t _R	Rise Time	-	-	15	ns
t _F	Fall Time	-	-	15	ns

6800-series MPU Parallel Interface Characteristics

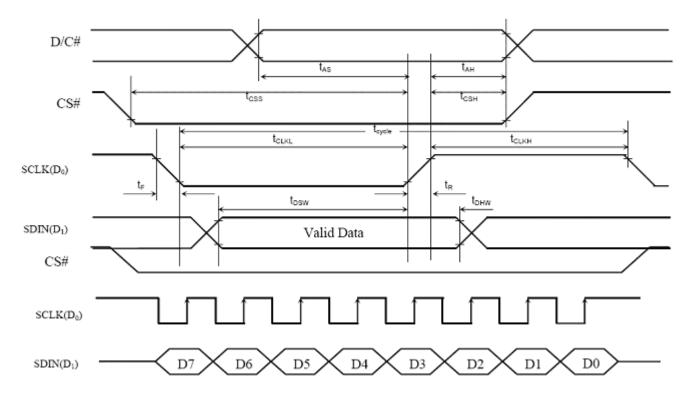




Serial Interface

Symbol	Parameter	Min	Тур	Max	Unit
t_{cycle}	Clock Cycle Time	250	-	-	ns
t_{AS}	Address Setup Time	150	-	-	ns
t_{AH}	Address Hold Time	150	-	-	ns
t _{CSS}	Chip Select Setup Time	120	-	-	ns
t _{CSH}	Chip Select Hold Time	60	-	-	ns
t _{DSW}	Write Data Setup Time	100	-	-	ns
t_{DHW}	Write Data Hold Time	100	-	-	ns
t_{CLKL}	Clock Low Time	100	-	-	ns
t_{CLKH}	Clock High Time	100	-	-	ns
t _R	Rise Time	-	-	15	ns
t _F	Fall Time	-	-	15	ns

Serial Interface Characteristics





9.2 Display Control Instruction

Command Table

(D/C# = 0, R/W# (WR#) = 0, E (RD#) = 1) unless specific setting is stated

200000000000000000000000000000000000000	damenta			_		-	la constant				
D/C	31,524,524	$\mathbf{D}7$	D6			-	D2		D0		Description
0	15 A[5:0]	0	0	0 A ₅	1 A4	0 A ₃	1 A2	0 A_1	$\begin{vmatrix} 1 \\ A_0 \end{vmatrix}$	Set Column Address	Second command A[5:0] sets the column start address from 0-63, POR = 00h
0	B[5:0]	*	*	100	Service of the last	\mathbf{B}_3		\mathbf{B}_1			Third command B[5:0] sets the column end address from 0-63, RESET = 3Fh
0	75	0	1	1	1	0	1	0	13324	Set Row address	Second command A[6:0]sets the row start address from 0-79, RESET = 00h
0	A[6:0] B[6:0]	*	B_6			A ₃ B ₃	\mathbf{A}_2 \mathbf{B}_2				Third command B[6:0] sets the row end address from 0 79, RESET = 4Fh
0	81 A[6:0]	1	0 A ₆	0 A ₅	0 A ₄	0 A ₃	0 A ₂	0 A ₁	1.000	Set Contrast Current	Double byte command to select 1 out of 128 contrast steps. Contrast increases as level increase
							_				The level is set to 40h after RESET
0	84~86	1	0	0	0	0	1	X_1	X ₀	Set Current Range	84h = Quarter Current Range (RESET) 85h = Half Current Range 86h = Full Current Range
0	A0	1	0	1	0	0	0	0	0	Set Re-map	A[0]=0, Disable Column Address Re-map (RESET)
0	A[6:0]	*	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A_0		A[0]=1, Enable Column Address Re-map A[1]=0, Disable Nibble Re-map (RESET)
											A[1]=1, Enable Nibble Re-map
											A[2]=0, Horizontal Address Increment (RESET) A[2]=1, Vertical Address Increment
										3	A[4]=0, Disable COM Re-map disable (RESET) A[4]=1, Enable COM Re-map
										1	A[5]=0, Reserved (RESET) A[5]=1, Reserved
										, a	A[6]=0, Disable COM Split Odd Even (RESET) A[6]=1, Enable COM Split Odd Even
0	A1	1	0	1	0	0	0	0	1	Set Display Start Line	Set display RAM display start line register from 0-79
0	A[6:0]	*	A ₆	A ₅	A_4	A_3	A ₂	A ₁	A_0		Display start line register is reset to 00h after RESET
0	A2	1	0	1	0	0	0	1	0	Set Display Offset	Set vertical scroll by COM from 0-79
0	A[6:0]	*	A_6	A ₅	A ₄	A ₃	A ₂	A_1	1150	(CONTRACTOR SERVICE S	The value is reset to 00H after RESET
0	A4~A7	1	0	1	0	0	X ₂	X_1	X_0	Set Display Mode	A4h = Normal Display (RESEΓ)
											A 5h = Entire Display ON,



Fund	amental	Co	mm	and	Tab	le				d.	
D/C	Hex	$\mathbf{D}7$	D6	D5	D4	D3	D2	D1	$\mathbf{D}0$	Command	Description
		0								g = 10 (d = 4 00 d = 4 d	all pixels turns ON in GS level 15
											A6h = Entire Display OFF, all pixels turns OFF
											A7h = Inverse Display
0 0	A8 A[6:0]	1 *	0 A ₆	1 A ₅	0 A ₄	1 A ₃	0 A ₂	0 A ₁		Set Multiplex Ratio	The next command determines multiplex ratio N from 16MUX-80MUX, A[6:0] = 15 represents 16MUX A[6:0] = 16 represents 17MUX : A[6:0] = 78 represents 79MUX A[6:0] = 79 represents 80MUX
0 0	AD A[1:0]	1 *	0 *	1 *	0 *	1 *	1 *	0 1		Set Master Configuration	$A[0] = 0$, Select external V_{CC} supply $A[0] = 1$, Reserved (RESET) Note (1) Bit $A[0]$ must be set to 0b after RESET. (2) The setting will be activated after issuing Set Display
0	AE	1	0	1	0	1	1	1	0	Set Display OFF	ON command (AFh) AEh = Display OFF (Sleep mode) (RESET)
0	AF	1	0	1	0	1	1	1	1	Set Display ON	AFh = Display ON
0	В0	1	0	1	1	0	0	0	0	Set Pre-charge Compensation Enable	A[5:0] = 08h (RESET)
0	A[5:0]	*	*	A ₅	A ₄	A ₃	\mathbf{A}_2	\mathbf{A}_1	A_0	•	A[5:0] = 28h, Enable pre-charge compensation
0	B1 A[3:0]	1	0	1	1	0 A ₃	0 A ₂	1.5	1 A ₀	Set Phase Length	A[3:0] = P1, phase 1 period of 1-15 DCLKs, RESET = 3DCLKS = 3h
0	A[7:4]	A ₇	A_6	A ₅	A ₄	*	*	*	*		A[7:4] = P2, phase 2 period of 1-15 DCLKs, RESET = 5DCLKS = 5h Note (1) 0 DCLK is invalid in phase 1 & phase 2
0	В2	1	0	1	1	0	0	1	-154	Set Row Period	The next command sets the number of DCLKs, K,
0	A[7:0]	A ₇	A_6	A ₅	A ₄	A ₃	A ₂	A_1	A_0		per row between 2-158 DCLKS RESET = 37DCLKS = 25h The K value should be set as K = P1+P2+GS15 pulse width (RESET: 3+5+29DCLKS)
0	В3	1	0	1	1	0	0	1	l	Set Display Clock	The lower nibble (A[3:0]) of the next command defines
0	A[3:0] A[7:4]	* A ₇	* A ₆	* A ₅	* A ₄	A ₃	A ₂	A ₁ *		Divide Ratio / Oscillator Frequency	the divide ratio (D) of display clock (DCLK) Divide ratio (D)=A[3:0]+1 (A[3:0]RESET is 0001b, i.e. divide ratio (D) = 2)



	Hex	\mathbf{D}^{γ}	D6	D5	D4	D3	D2	D1	$\mathbf{D}0$	Command	Description
											The higher nibble (A[7:4]) of the next command sets the Oscillator Frequency Oscillator Frequency increases with the value of A[7:4] and vice versa Range: 0000b~1111b RESET= 0100b represents 655KHz, typical step value: 5% of previous value
0	B4	1	0	1	1	0	1	0	0	Set Pre-charge	A[2:0] = 0 (RESET)
0	A[2:0]	*	*	*	*	*	1000	A_1			A[2:0] = 3h, Recommended level
0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	B8 A[2:0] B[2:0] B[6:4] C[2:0] C[6:4] D[2:0] D[6:4] E[2:0] E[6:4] F[2:0] G[6:4] H[2:0] H[6:4]	1 * * * * * * * * * * * * * * * * * * *	0 * * B6 * C6 * E6 * F6 * H6	1 * * B5 * C5 * E5 * G5 * H5	1 * * B4 * C4 * E4 * F4 * H4	1 * * * * * * * * * * * * * * * * * * *	0 A ₂ B ₂ * C ₂ * E ₂ * F ₂ * H ₂ *	0 A ₁ B ₁ * C ₁ * D ₁ * F ₁ * H ₁ *	$\begin{array}{c} A_0 \\ B_0 \\ * \\ C_0 \\ * \\ D_0 \\ * \\ E_0 \\ * \\ G_0 \\ * \end{array}$		The next eight bytes of command set the gray scale level of GS1-15 as below: A[2:0] = Gray scale level of GS1, RESET=1 B[2:0] = Gray scale level of GS2, RESET=1 B[6:4] = Gray scale level of GS3, RESET=1 C[2:0] = Gray scale level of GS4 RESET=1 C[6:4] = Gray scale level of GS5, RESET=1 D[2:0] = Gray scale level of GS6, RESET=1 D[6:4] = Gray scale level of GS7, RESET=1 E[2:0] = Gray scale level of GS8, RESET=1 E[2:0] = Gray scale level of GS8, RESET=1 E[6:4] = Gray scale level of GS10, RESET=1 F[2:0] = Gray scale level of GS11, RESET=1 F[6:4] = Gray scale level of GS12, RESET=1 G[2:0] = Gray scale level of GS13, RESET=1 H[2:0] = Gray scale level of GS14, RESET=1 H[2:0] = Gray scale level of GS15, RESET=1
0 0	BC A[7:0]	1 A7	0 A6	1 A5	1 A4	1 A3	1 A2	0 A1		Set Precharge Voltage	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$
0	BE	1	0	1	1	1	1	1	0	Set V _{COMH} Voltage	Second command A[4:0] sets the V _{COMH} voltage level
	A[4:0]	**	*	0	A4	A3	A2	A1			A[4:0] 00000 0.51*V _{REF} 00001 0.52* V _{REF} 11101 0.81* V _{REF} (RESET) 11110 0.82* V _{REF} 11111 0.84* V _{REF}
0	BF A[3:0]	1 *	0 *	1 *	1 *	1 A ₃	1 A ₂	1 A ₁	1 A ₀		Second command A[3:0] sets the VSL voltage as follow: $A[3:0] = 0010 \text{kept VSL pin NC} \\ A[3:0] = 1110 \; (\text{RESET}) \; \text{connect a capacitor between} \\ VSL \; \text{pin and V}_{\text{SS}}$
l											



Graphic acceleration command

Set (GAC) (D/C# = 0, R/W#(WR#)= 0, E(RD#) = 1) unless specific setting is stated

Grapi	ic accel	erati) = 1) unless specific setting is stated
D/C#		D 7	_	D5			D2	D2	$\mathbf{D}0$	Command	Description
0 0	23 A[4:0]	0 **	0 *	1 *	0 A ₄	0 *	0 *	1 A ₁	1 A ₀	Graphic Acceleration Command Options	A[0] = 0b: Disable Fill rectangle A[0] = 1b: Enable Fill rectangle (RESET) A[1] = 0b: Disable x-wrap(RESET) A[1] = 1b: Enable wrap around in x-direction during copying and scrolling A[4] = 0b: Disable reverse copy (RESET) A[4] = 1b: Enable reverse during copying.
0	24	0	0	1	0	0	1	0	0		A[5:0]: Column Address of Start
0 0 0 0	A[5:0] B[6:0] C[5:0] D[6:0] E[7:0]	* * * E ₇	* B ₆ * D ₆ E ₆	A ₅ B ₅ C ₅ D ₅ E ₅	A ₄ B ₄ C ₄ D ₄ E ₄	A ₃ B ₃ C ₃ D ₃ E ₃	A_2 B_2 C_2 D_2 E_2	A_1 B_1 C_1 D_1 E_1	A_0 B_0 C_0 D_0 E_0		B[6:0]: Row Address of Start C[5:0]: Column Address of End D[6:0]: Row Address of End E[7:0]: Set Gray scale pattern E[7:0] This byte is divided into two nibbles. The most significant 4 bits represent the gray scale
										Draw Rectangle	
0 0 0 0	25 A[5:0] B[6:0] C[5:0] D[6:0]	0 * *	0 * B ₆ * D ₆	1 A ₅ B ₅ C ₅ D ₅	0 A ₄ B ₄ C ₄ D ₄	B ₃ C ₃	$1 \\ A_2 \\ B_2 \\ C_2 \\ D_2$	$0 \\ A_1 \\ B_1 \\ C_1 \\ D_1$	$egin{array}{c} B_0 \ C_0 \end{array}$		A[5:0]: Column Address of Start B[6:0]: Row Address of Start C[5:0]: Column Address of End
0 0	E[5:0] F[6:0]	oje oje	* F ₆	E ₅	E ₄ F ₄	and the second	E ₂ F ₂	E ₁ F ₁	E ₀ F ₀	Сору	D[6:0]: Row Address of End E[5:0]: Column Address of New Start F[6:0]: Row Address of New Start Note: $(1) 0 \le A < C \le 63$ $(2) 0 \le B < D \le 79$ $(3) 0 \le E \le 63$ $(4) 0 \le F \le 79$



D / C #	Hex	$\mathbf{D}7$	D6	D5	D4	D3	D2	D2	D0	Command	Description
0	26 A[5:0]	0	0	1 A ₅	0 A ₄	0 A ₃	1 A ₂	1 A ₁	0 A ₀		A[5:0]: 1~63 horizontal offset in number of 2~127 column on horizontal scroll
0	B[6:0]	*	B_6	\mathbf{B}_{5}	B_4	\mathbf{B}_3	\mathbf{B}_2	B_1	B_0		B[6:0]: 2~80 number of rows to be H-scrolled
0	C[1:0]	*	*	sąc	*	*	*	Cı	C ₀	Horizontal Scroll	C[1:0]: scrolling time interval 00b 12 frames 01b 64 frames 10b 128 frames 11b 256 frames Note: (1) Scrolling operates during display ON. (2) The parameters should not be changed after scrolling is activated
0	2E	0	0	1	0	1	1	1	0	Stop Moving	This command deactivates the scrolling action. Note (1) After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritten.
0	2F	0	0	1	0	1	1	1	1	Start Moving	This command activates the scrolling function according to the setting done by Horizontal Scroll command 26h. Note (1) The "wrap around in x-direction" function must be enabled before scrolling start. i.e. Bit A{1} of command 23h must be set to 1b before issuing 2F command.

Read Command Table

(D/C#=0, R/W# (WR#)=1, E (RD#)=1 for 6800 or E (RD#)=0 for 8080)

		D7 = 0:reserved	
		D7 = 1:reserved	
DDDDDD		D6 = 0:indicates the display is ON	
$D_7D_6D_5D_4D_3D_2D_1$	g, , , , , , , , , , , , , , , , , , ,	D6 = 1:indicated the display is OFF	
\mathbf{D}_0	Status Register Read	D5 = 0:reserved	
		D5 = 1:reserved	
		D4 = 0:reserved	
		D4 = 1:reserved	

Note
(1) Patterns other than that given in Command Table are prohibited to enter to the chip as a command; Otherwise, unexpected result will occur

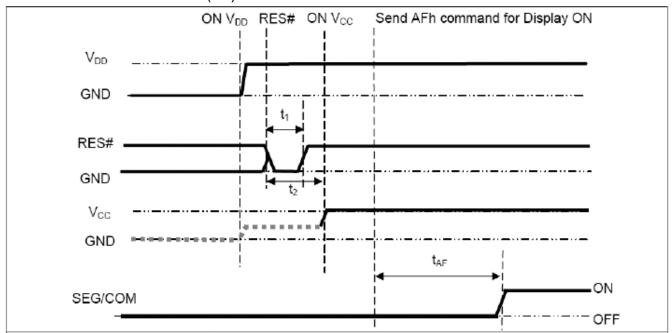


9.3Power ON and OFF sequence& Application Circuit

9.3.1 POWER ON / OFF SEQUENCE

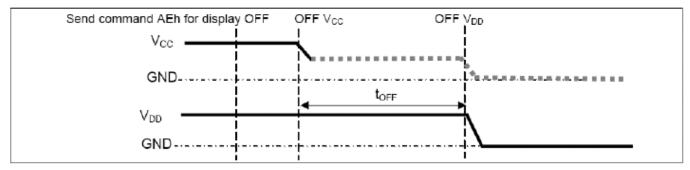
Power ON sequence:

- 1. Power ON VDD.
- 2. After VDD become stable, set RES# pin LOW (logic low) for at least 3us(t1) and then HIGH (logic high).
- 3. After set RES# pin LOW (logic low), wait for at least 3us(t2). Then Power ON Vcc.(1)
- 4. After Vcc become stable, send command AFh for display ON. SEG/COM will be ON after 100ms(taf).



Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Wait until panel discharges completely.
- 3. Power OFF Vcc. (1), (2)
- 4. Wait for toff. Power OFF VDD. (where Minimum toff=80ms, Typical toff=100ms)



Note:

- (1) Since an ESD protection circuit is connected between VDD and VCC, VCC becomes lower than VDD whenever VDD is ON and VCC is OFF as shown in the dotted line of VCC in above figures.
- (2)VCC should be disabled when it is OFF.



10. Quality Assurance

10.1 Inspection conditions

1. The inspection and meaurement are performed under the following conditions,

2. unless otherwise specified.

3. Temperature: 25±5°C

4. Humidity: 50±10%R.H.

5. Distance between the panel and eyes of the inspector≥30cm

10.2 Inspection Parameters

Severity	Inspection Item	Defect	Remark		
		(1) Non-displaying			
	1. Panel	(2) Line defects			
	i. Failei	(3) Malfunction			
Major		(4) Glass cracked			
Defect	2. Film	(1) Film dimension out of	Can not be		
	2.1 11111	specification	assembled		
	3. Dimension	(1) Outline dimension out	/ /		
9	3. Difficion	of specification	\ //		
		(1) Glass scratch	VIII		
	1. Panel	(2) Glass cutting NG			
		(3) Glass chip			
		(1) Polarizer scratch	Annogrance		
Minor	2. Polarizer	(2) Stains on surface	Appearance		
Defect		(3) Polarizer bubbles	defect		
	2 Displaying	(1) Dim spot \	delect		
	3. Displaying	Bright spot \ dust			
	4. Film	(1) Damage			
		(2) Foreign material			



D		Ouitanian			401
Description		Criterion			AQL
	Width (mm) W	Length (mm) L	number pieces permitt	s	
	W≦0.03	Ignore	Ignor	е	
1. Glass scratch	0.03< W≦0.05	L≦3	3		Minor
	0.05< W		None	,	
	beyond A.A.		Ignor	е	
	Size	number pieces per	_		
2. Polarizer	Ф ≦0.2	Ignor	е		
bubble	$0.2 < \Phi \le 0.5$	2			Minor
Bubbic	0.5<Ф	0			
	beyond A.A.	Ignor	е		/
	average	number	r of		
	D ≦0.1	Ignor	е		
3. Dimming spot \	0.1 < D ≤0.15				
Lighting spot · Dust	0.15< D ≤0.2	1			Minor
	0.2 < D	0 Ignor			
	beyond A.A.				
	D=(long diamete				
	Fixel oil is not allo	owea.			



10.3 WARRANTY POLICY

Bolymin . Will provide one-year warranty for the products only if under specification operating conditions.

If there are functional defects found during the period of warranty, the defective products would be replaced on a one-to-one basis.

Bolymin would not be responsible for any direct/indirect liabilities consequential to any parties.

10.4 MTBF

10.4.1 .MTBF based on specific test condition is 40K hours.

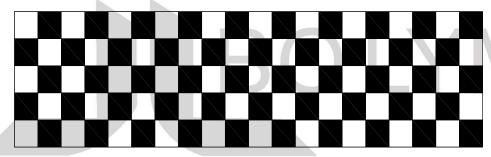
10.4.2 Test Condition:

10.4.2.1 Supply Voltage: Vcc=12V

10.4.2.2 Luminance: 100cd/m2

10.4.2.3 Operation temperature and humidity: 25 °C and 50%RH

10.4.2.4 Run-Patterns:



10.4.3 Test Criteria:

Luminace has decayed to less than 50% of the initial measured luminance.



11.Reliability

■Content of Reliability Test

NO.	Items.	Specification	Applicable Standard		
1	High temp. (Non-operation)	85°C, 240hrs			
2	High temp. (Operation)	70°C, 120hrs			
3	Low temp. (Operation)	-40°C, 120hrs			
4	High temp. / High. humidity (Operation)	65°C, 90%RH, 120hrs			
5	Thermal shock(Non-operation)	-40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 100 cycles.			
6	Vibration	Frequency: 5~50HZ, 0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X, Y, Z			

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for item 1 & 4 & 5.

Criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: >50% of initial value.
- 4. Current consumption: within ±50% of initial value.

Reliability Test

Bolymin only guarantees the reliability of the panel under the test conditions and durations listed in the specification, and is not responsible for any test results that are conducted using more stringent conditions and/or with lengthened durations. Also, when the testing the panel in a chamber or oven, make sure they won't produce any condensation on the panel, especially on the electrical leads, before lighting on the panel to see if it passes the test. Also the panel should rest for about an hour at room temperature and pressure before the measurement, as indicated in the specification. Be aware that one should use fresh panel for each of the reliability test items listed in the specification, in other words, don't use the panels that were tested for subsequent tests.



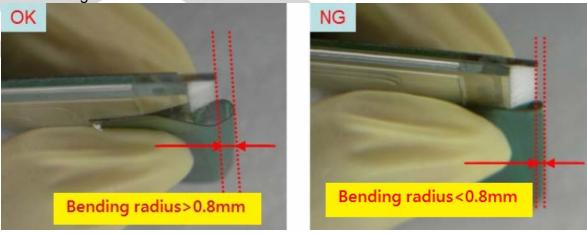
12. Precautions for Handling

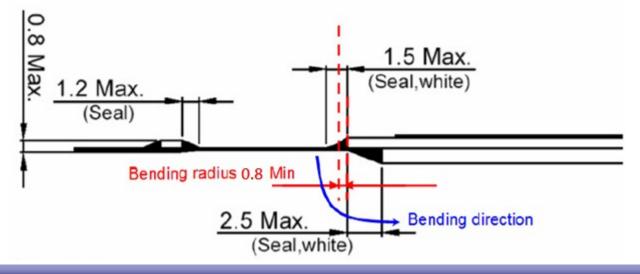
- 12.1 When handling the module, wear powder-free antistatic rubber finger cots, and be careful not to bend and twist it.
- 12.2 The OLED module is consisted of glass and film, and it should avoid pressure, strong impact, or being dropped from a height.
- 12.3 The OLED module is an electronic component and is subject to damage caused by Electro Static

Discharge (ESD) and hence normal ESD precautions must be taken when handling it. Also, appropriate ESD protective environment must be administered and maintained in the production line. When handling and assembling the panel, wear an antistatic wrist strap with the alligator clip attached to the ground to prevent ESD damage on the panel. Also, ground the tools being used for panel assembly and make sure the working environment is not too dry to cause ESD problems. (See the photos below).



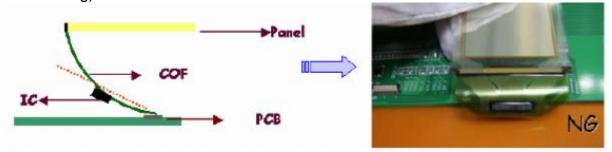
12.4 Please do not bend the film near the substrate glass.(this could cause film peeling and COF damage) and the peeling strength about 600g/cm, the bending <20times and the bending radius :R>0.8mm



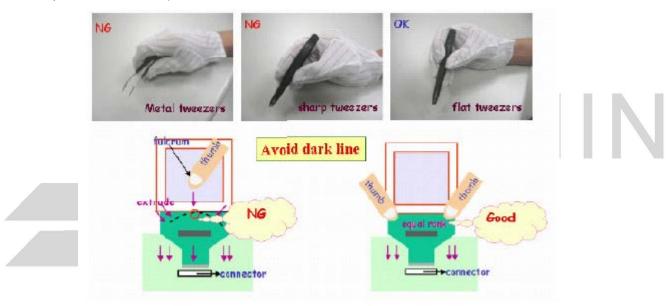




12.5 Avoid bending the film at IC bonding area.(>1.5mm)(this could damage the ILB bonding)



12.6 Use both thumbs to insert COF into the connector when assembling the panel. See the photo on the far right below for correct insertion of the film into the connector (one-handed insertion exerts uneven force on the film and could cause its breakage, photo on the left)



12.7 Do not wipe the pin of film with the dry or hard materials that will damage the surface. When cleaning the display surface, use soft cloth solvent and wipe gently (Recommend solvent: IPA, alcohol), and do not wipe the display with dry or hard materials that will damage the polarizer surface and do not use the solvent like: Water, Acetone, Aromatic



13. Precautions for Electrical

13.1 Design using the settings in the specification

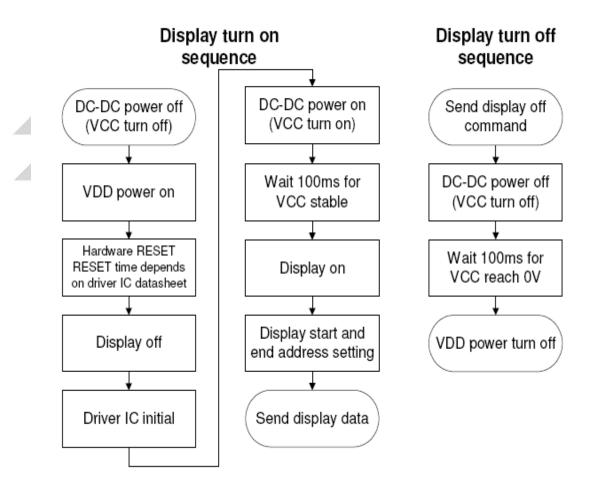
It is extremely important to design and operate the panel using the settings listed in the specification. This includes voltage, current, frame rate, duty cycle... etc. Operation of the OLED outside the specified range in the specification should be entirely avoided to ensure proper operation of the OLED.

13.2 Maximum Ratings

To ensure proper operation of the panel, never design the panel with parameters running over the maximum ratings listed in the specification. Also the logic voltages such as VIL and VIH have to be within the specified range in the specification to prevent any improper operation of the panel.

13.3 Power on/off procedure

Any operation that does not comply with the procedure could cause permanent damage of the IC and should be avoided. When the logic power is not on, do not activate any input signal. Abrupt shutdown of power to the module, while the OLED panel is on, could cause OLED panel malfunctioning.



13.4 Power savings

To save power consumption of the OLED, one can use partial display or sleep mode when the panel is not fully activated. Also, if possible, make maximum use of black background to save power. The OLED is a self-luminous device, and a particular pixel cluster or image can be lit on via software control, so power savings can be achieved by partial display or dimming down the luminance. Depending on the application, the user can choose among Ultra Bright Mode, Normal Operation Mode, and Sleeping Mode.



The power consumption is almost in direct proportion to the brightness of the panel, and also in direct proportion to the number of pixels lit on the panel, so the customer can save the power by the use of black background and Sleeping Mode. One benefit from using these design schemes is the extension of the OLED lifetime.

13.5 Residual Image (Image Sticking)

The OLED is a self-emissive device. As with other self-emissive device or displays consisting of self-emissive pixels, when a static image frozen for a long period of time is changed to another one with all-pixels-on background, residual image or image sticking is noticed by the human eye. Image sticking is due to the luminance difference or contrast between the pixels that were previously turned on and the pixels that are newly turned on. The time when image sticking happens depends on the luminance decay curve of the display. The slower the decay, the less prominent the image sticking is. It is strongly recommended that the user employ the following three strategies to minimize image sticking

- 13.5.1Employ image scrolling or animation to even out the lit-on time of each and every pixel on the display, also could use sleeping mode for reduced the residual image and extend the power capacity.
- 13.5.2Minimize the use of all-pixels-on or full white background in their application because when the panel is turned on full white, the image sticking from previously shown patterns is the most revealing. Black background is the best for power savings, greatest visibility, eye appealing, and dazzling displays
- 13.5.3If in the reliability test when a static logo is used, change the pattern into its inverse (i.e., turn off the while pixels and turn on the previously unlit pixels) and freeze the inverse pattern as long as the original logo is used, so every pixel on the panel can be lit on for about the same time to minimize image sticking, caused by the differential turn-on time between the original and its reverse patterns

14. Precautions for Storage

Although the storage conditions and guarantee period are indicated in the specification, it is advisable to store the packed cartons or packages at 23°C±5°C,55%±10%RH, Do not store the OLED module under direct sunlight or UV light and for best panel performance, unpack the cartons and start the production with the panels within one months after the reception of them.